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# ISL9R860P2, ISL9R860S3ST

# 8 A, 600 V, STEALTH™ Diode

### Features

- Stealth Recovery  $t_{rr}$  = 28 ns (@ IF = 8 A)
- Max Forward Voltage, VF = 2.4 V (@ TC = 25°C)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

### Applications

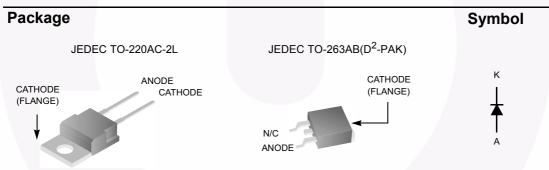
- SMPS FWD
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- Snubber Diode

### Description

The ISL9R860P2, ISL9R860S3ST is a STEALTH<sup>TM</sup> diode optimized for low loss performance in high frequency hard switched applications. The STEALTH<sup>TM</sup> family exhibits low reverse recovery current (I<sub>RR</sub>) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I<sub>RR</sub> and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH<sup>TM</sup> diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

SL9R860P2, ISL9R860S3ST — STEALTH™ Diode

November 2013

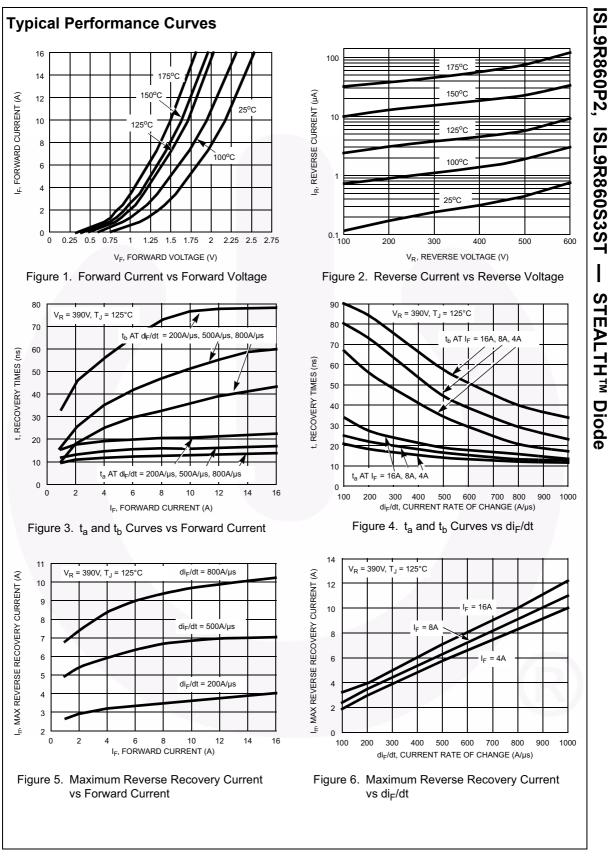


# Device Maximum Ratings Tc= 25°C unless otherwise noted

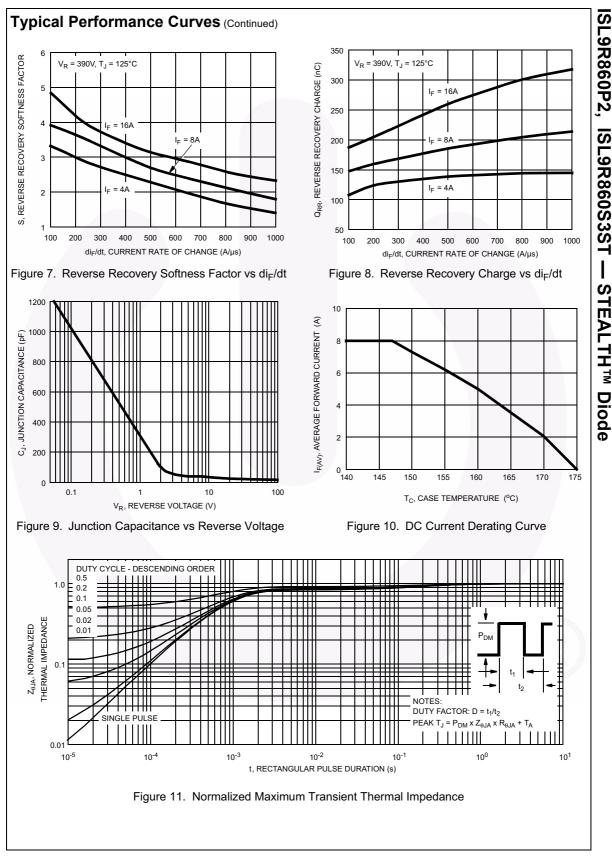
| Symbol                             | Parameter  | Ratings    | Unit   |
|------------------------------------|--|------------|--------|
| V <sub>RRM</sub>                   | Peak Repetitive Reverse Voltage  | 600        | V      |
| V <sub>RWM</sub>                   | Working Peak Reverse Voltage   | 600        | V      |
| V <sub>R</sub>                     | DC Blocking Voltage  | 600        | V      |
| I <sub>F(AV)</sub>                 | Average Rectified Forward Current (T <sub>C</sub> = 147 <sup>o</sup> C)  | 8          | Α      |
| I <sub>FRM</sub>                   | Repetitive Peak Surge Current (20kHz Square Wave)  | 16         | Α      |
| I <sub>FSM</sub>                   | Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)   | 100        | Α      |
| PD                                 | Power Dissipation  | 85         | W      |
| E <sub>AVL</sub>                   | Avalanche Energy (1 A, 40 mH)  | 20         | mJ     |
| Γ <sub>J</sub> , T <sub>STG</sub>  | Operating and Storage Temperature Range  | -55 to 175 | °C     |
| T <sub>L</sub><br>T <sub>PKG</sub> | Maximum Temperature for Soldering<br>Leads at 0.063in (1.6mm) from Case for 10s<br>Package Body for 10s, See Techbrief TB334 | 300<br>260 | ℃<br>℃ |

|                                    | ber Top Mark  | Package                              | Packing Me  | thod     | Reel Size                | e Tap | be Wic    | lth ( | Quantity |
|------------------------------------|---|--------------------------------------|---|----------|--------------------------|-------|-----------|-------|----------|
| SL9R860F                           | 2 ISL9R860P2  | TO-220AC-2L                          | Tube  |          | N/A                      |       | N/A       |       | 50       |
|                                    |   | TO-263AB(D <sup>2</sup> -PAK) Reel   |   |          | 13" Dia 24mm             |       | 800       |       |          |
|                                    |   |                                      |   |          |                          |       |           |       |          |
| Electric                           | cal Characteri  | <b>STICS</b> T <sub>C</sub> = 25°C u | nless otherwise   | noted    |                          |       |           |       |          |
| Symbol                             | Parar   | meter                                | Test C  | ondition | S                        | Min   | Тур       | Max   | Unit     |
| Off State                          | Characteristics   |                                      |   |          |                          |       |           |       |          |
| I <sub>R</sub>                     | Instantaneous Reverse Current   |                                      |   | = 25°C   | -                        | -     | 100       | μA    |          |
| IX.                                |   |                                      |   |          | = 125°C                  | -     | -         | 1.0   | mA       |
| Om State                           | Characteristics   |                                      |   |          |                          |       |           |       |          |
|                                    | Characteristics   |                                      |   | <u> </u> | 05%0                     |       | 0.0       | 0.4   |          |
| V <sub>F</sub>                     | Instantaneous Forwa   | ard Voltage                          | I <sub>F</sub> = 8 A                                    |          | = 25°C                   | -     | 2.0       | 2.4   | V        |
|                                    |   |                                      |   | 1C -     | = 125°C                  | -     | 1.6       | 2.0   | V        |
| Dynamic                            | Characteristics   |                                      |   |          |                          |       |           |       |          |
| CJ                                 | Junction Capacitance  | e                                    | V <sub>R</sub> = 10 V, I <sub>F</sub> = 0               | A        |                          | -     | 30        | -     | pF       |
|                                    |   |                                      |   |          |                          |       |           |       |          |
|                                    | g Characteristic  |                                      |   |          |                          |       |           |       |          |
| t <sub>rr</sub>                    | Reverse Recovery T  | ïme                                  | $I_F = 1 A$ , $di_F/dt =$                               |          |                          | -     | 18        | 25    | ns       |
|                                    |   |                                      | $I_F = 8 A, di_F/dt =$                                  | 100 A/µ  | s, V <sub>R</sub> = 30 V | -     | 21        | 30    | ns       |
| t <sub>rr</sub>                    | Reverse Recovery T  |                                      | $I_{F} = 8 \text{ A},$                                  |          | _                        | 28    | -         | ns    |          |
| I <sub>rr</sub>                    | Reverse Recovery C  |                                      |   |          |                          | 3.2   | -         | A     |          |
| Q <sub>rr</sub>                    | Reverse Recovery C  |                                      |   |          | -                        | 50    | -         | nC    |          |
| t <sub>rr</sub>                    | Reverse Recovery T  |                                      | I <sub>F</sub> = 8 A,<br>di <sub>F</sub> /dt = 200 A/μs |          | -                        | -     | 77        | -     | ns       |
| S                                  | Softness Factor (t <sub>b</sub> /t <sub>a</sub>                       | a,                                   | $V_{R} = 390 V,$  |          | -                        | -     | 3.7       | -     |          |
| I <sub>rr</sub>                    | Reverse Recovery C  |                                      | $T_{\rm C} = 125^{\circ}{\rm C}$                        |          |                          | -     | A         |       |          |
| Q <sub>rr</sub>                    | Reverse Recovery C  | -                                    | - 150   |          | -                        | nC    |           |       |          |
| t <sub>rr</sub>                    | Reverse Recovery T  |                                      | I <sub>F</sub> = 8 A,<br>di <sub>F</sub> /dt = 600 A/μs |          | -                        | -     | 53<br>2.5 | -     | ns       |
| S                                  | Softness Factor (t <sub>b</sub> /t <sub>a</sub><br>Reverse Recovery C |                                      | $V_{\rm R} = 390  \rm V,$                               |          | -                        | -     | _         | -     | A        |
| I <sub>rr</sub><br>Q <sub>rr</sub> | Reverse Recovery C  |                                      | T <sub>C</sub> = 125°C                                  |          | -                        | nC    |           |       |          |
| dI <sub>M</sub> /dt                | Maximum di/dt during  |                                      |   |          | _                        | 500   | -         | A/µs  |          |
| aiMat                              | Maximum ai/at dann  | 9 °b                                 | <u> </u>  |          |                          |       | 000       |       | 7745     |
|                                    | Characteristics   |                                      |   |          |                          |       |           |       |          |
| $R_{	extsf{	heta}JC}$              | Thermal Resistance  | Junction to Case                     |   |          |                          | -     | -         | 1.75  | °C/W     |
| $R_{\thetaJA}$                     | Thermal Resistance  | Junction to Ambient                  | TO-220  |          |                          | -     | -         | 62    | °C/W     |
| $R_{\thetaJA}$                     | Thermal Resistance  | Junction to Ambient                  | TO-263  |          |                          |       |           | 62    | °C/W     |
|                                    |   |                                      |   |          |                          |       |           |       |          |

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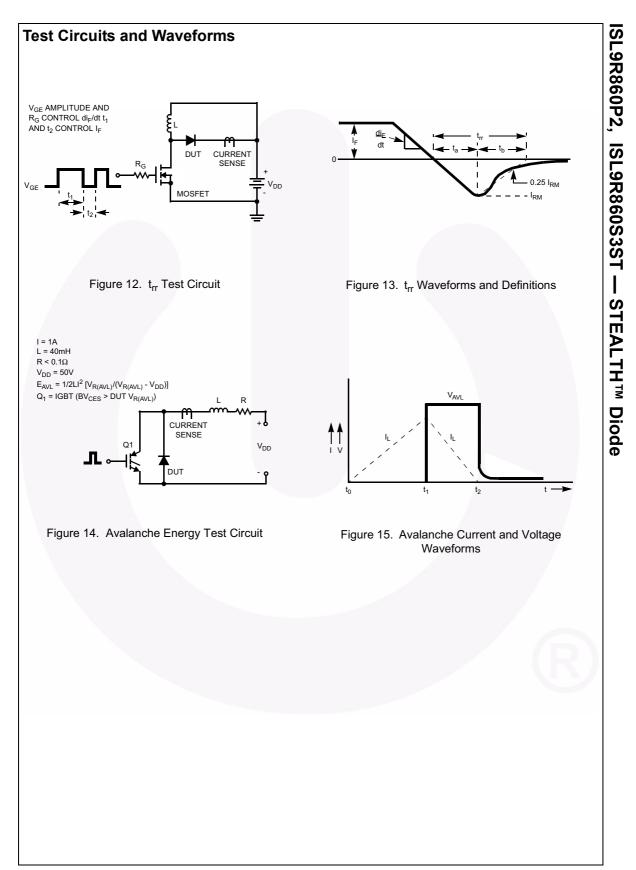


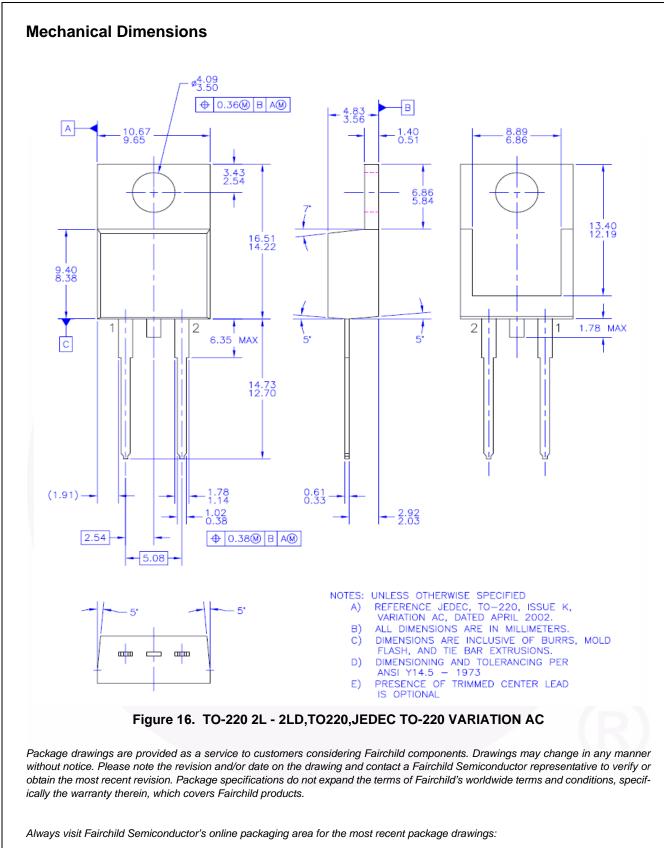
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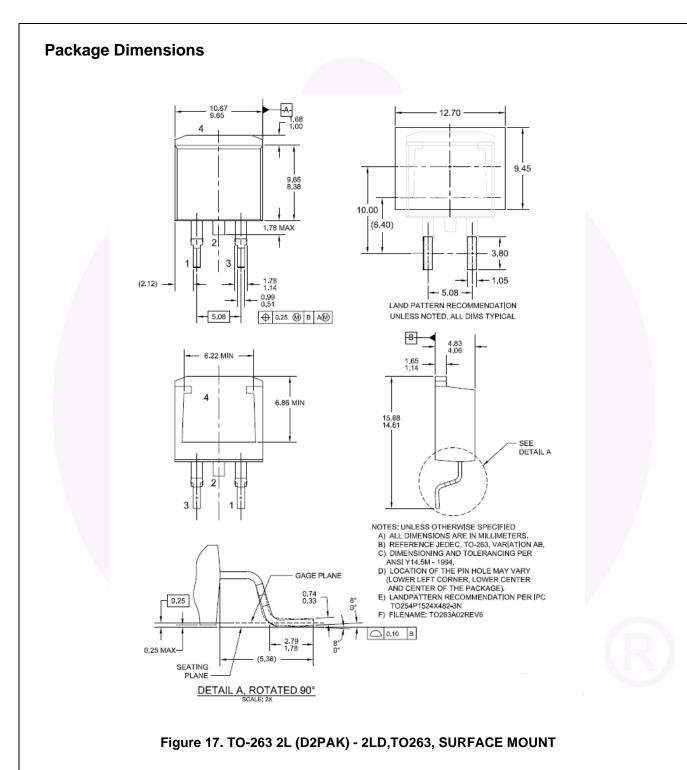
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